

ESDA14V2BP6

Application Specific Discretes A.S.D. TM

TRANSIL™

MAIN APPLICATIONS

Where transient overvoltage protection in ESD sensitive equipment is required, such as :

- Computers
- Printers
- Communication systems and cellular phones
- Video equipment

This device is particularly adpated to the protection of symmetrical signals.

FEATURES

- 4 Bidirectional Transil[™] functions.
- ESD Protection: IEC61000-4-2 level 4
- Stand off voltage: 12V MIN
- Low leakage current < 1µA

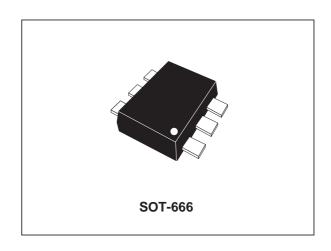
DESCRIPTION

The ESDA14V2BP6 is a monolithic array designed to protect up to 4 lines in a bidirectional way against ESD transients.

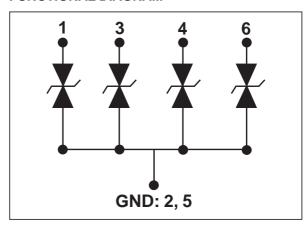
This device is ideal for applications where board space saving is required.

BENEFITS

- High ESD protection level.
- High integration.
- Suitable for high density boards.



FUNCTIONAL DIAGRAM



COMPLIES WITH THE FOLLOWING STANDARDS:

- IEC61000-4-2 level 4: 15 kV (air discharge) 8 kV (contact discharge)
- MIL STD 883E-Method 3015-7: class 3 25kV HBM (Human Body Model)

March 2003 - Ed: 3A 1/5

ESDA14V2BP6

ABSOLUTE RATINGS $(T_{amb} = 25^{\circ}C)$

Symbol	Parameter Test conditions		Value	Unit
V _{PP}	ESD discharge - IEC61000-4 IEC61000-4	± 15 ± 8	kV	
P _{PP}	Peak pulse power dissipation	50	W	
Tj	Junction temperature	125	°C	
T _{stg}	Storage temperature range	- 55 to + 150	°C	
TL	Maximum lead temperature fo	260	°C	
Top	Operating temperature range	- 40 to + 125	°C	

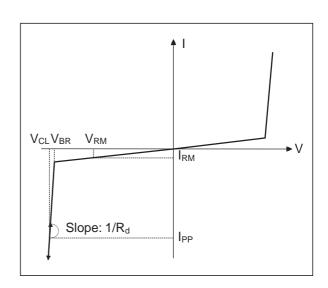
Note 1: for a surge greater than the maximum values, the diode will fail in short-circuit.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient on printed circuit on recommended pad layout	220	°C/W

ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C)

==== (· aiiib == 0)					
Symbol	Parameter				
V _{RM}	Stand-off voltage				
V_{BR}	Breakdown voltage				
V _{CL}	Clamping voltage				
I _{RM} Leakage current @ V _{RM}					
I _{PP} Peak pulse current					
αT Voltage tempature coefficient					
V _F Forward voltage drop					



Types	I _{RM} @ V _{RM}			V _{BR} @	l _R	Rd	αΤ	С
	max.		min.	max.		typ.	typ.	max.
	μA	V	V	V	mA	Ω	10 ⁻⁴ /°C	pF @ 0V
	1	12		18	1	1.5	5.8	25
ESDA14V2BP6	0.1	3	14.2					

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Fig. 1: Relative variation of peak pulse power versus initial junction temperature.

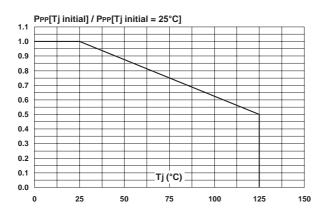


Fig. 2: Peak pulse power versus exponential pulse duration.

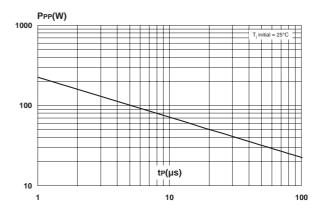


Fig. 3: Clamping voltage versus peak pulse current (typical values, rectangular waveform).

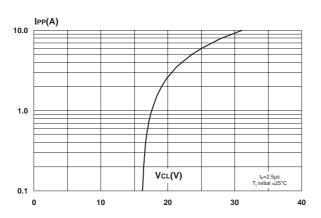


Fig. 4: Junction capacitance versus reverse voltage applied (typical values).

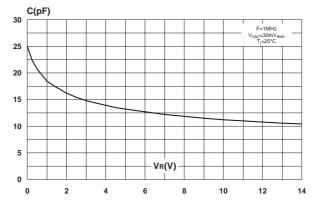
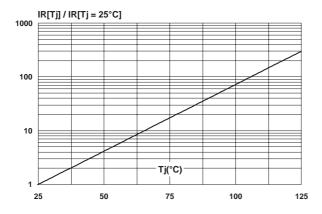
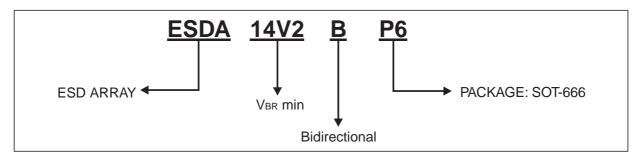


Fig. 5: Relative variation of leakage current versus junction temperature (typical values).



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ORDER CODE

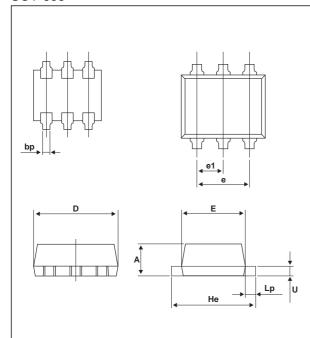


Ordering type	Marking	Package	Weight	Base qty	Delivery mode
ESDA14V2BP6	А	SOT-666	2.9 mg.	3000	Tape & reel 7"

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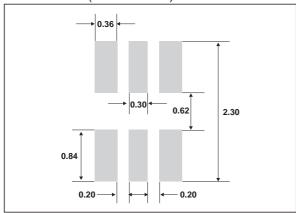
PACKAGE MECHANICAL DATA

SOT-666



	DIMENSIONS						
REF.	Millin	neters	Inches				
	Min.	Max.	Min.	Max.			
Α	0.50	0.60	0.020	0.024			
bp	0.17	0.27	0.007	0.011			
С	0.08	0.18	0.003	0.007			
D	1.50 1.70		0.060	0.067			
E	1.10	1.30	0.043	0.051			
е	1.00		0.040				
e1	0.50		0.020				
He	1.50	1.70	0.059	0.067			
Lp	0.10	0.30	0.004	0.012			

FOOT PRINT (in millimeters)



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